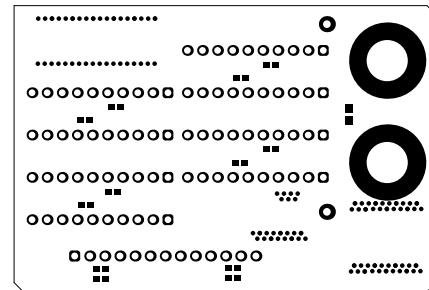
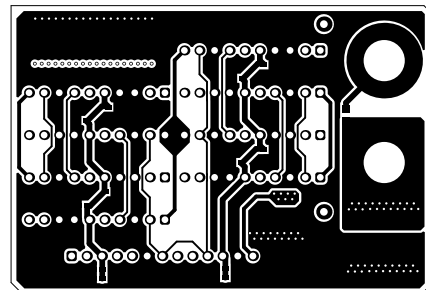


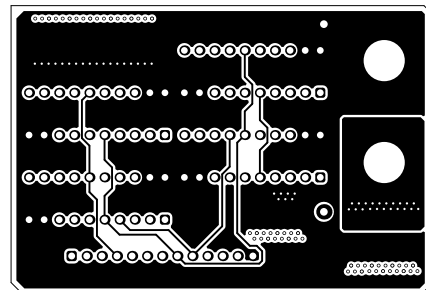
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Load Board A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A	
PLOT NAME = Top Overlay	GENERATED : 11/9/2017 3:44:30 AM	TEXAS INSTRUMENTS



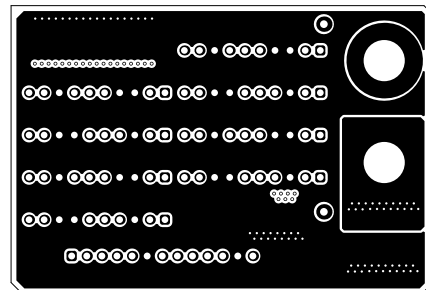
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Lqad Bld A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A	
PLOT NAME = Top Solder Mask	GENERATED : 11/9/2017 3:44:32 AM	TEXAS INSTRUMENTS



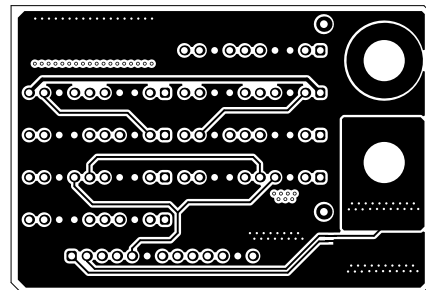
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Lqad Rev A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: N/A	
PLOT NAME = Top Layer	GENERATED : 11/9/2017 3:44:33 AM	TEXAS INSTRUMENTS



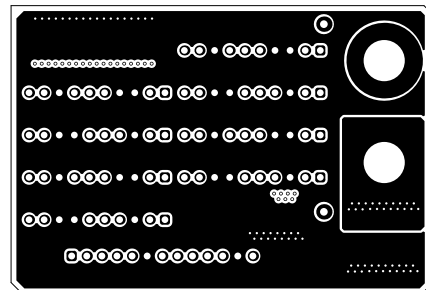
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Load Board A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: N/A	
PLOT NAME = Signal Layer 1	GENERATED : 11/9/2017 3:44:34 AM	TEXAS INSTRUMENTS



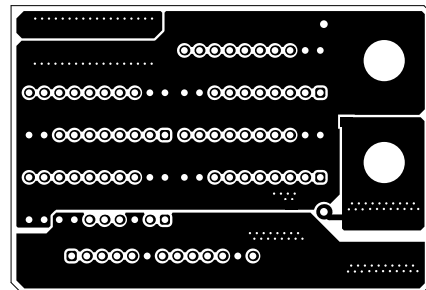
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Lqad Bld A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: N/A	
PLOT NAME = Signal Layer 2	GENERATED : 11/9/2017 3:44:35 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Lqad Rev A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: N/A	
PLOT NAME = Signal Layer 3	GENERATED : 11/9/2017 3:44:36 AM	TEXAS INSTRUMENTS

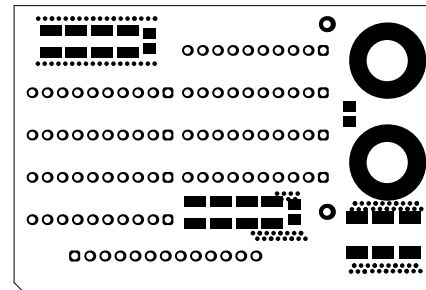


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Lqad Bld A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: N/A	
PLOT NAME = Signal Layer 4	GENERATED : 11/9/2017 3:44:37 AM	TEXAS INSTRUMENTS

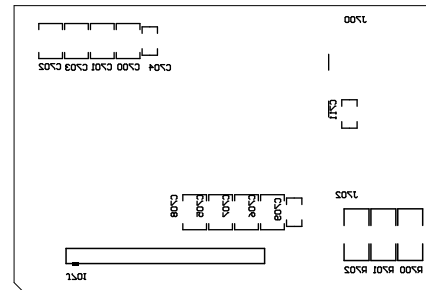


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Lqad Bld A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: N/A	
PLOT NAME = Bottom Layer	GENERATED : 11/9/2017 3:44:38 AM	TEXAS INSTRUMENTS



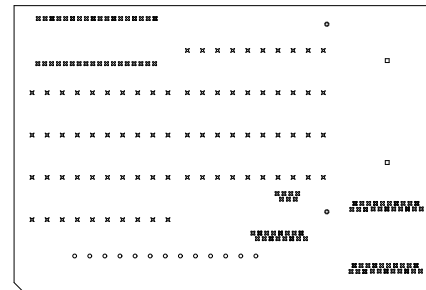


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Lqad B6Kd A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A	
PLOT NAME = Bottom Solder Mask	GENERATED : 11/9/2017 3:44:39 AM	TEXAS INSTRUMENTS

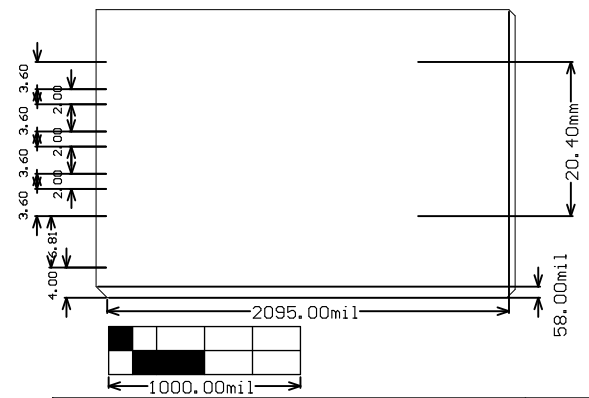


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Lqad Bld A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: N/A	
PLOT NAME = Bottom Overlay	GENERATED : 11/9/2017 3:44:41 AM	TEXAS INSTRUMENTS

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Tolerance
⊗	126	12.00mil (0.305mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	80	35.04mil (0.890mm)	PTH	Round	Top Layer - Bottom Layer	
○	13	35.83mil (0.910mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	2	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
□	2	214.57mil (5.450mm)	PTH	Round	Top Layer - Bottom Layer	
	223 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Lqad Rev A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: N/A	
PLOT NAME = Drill Drawing	GENERATED : 11/9/2017 3:44:42 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20978_Load Board A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A	
PLOT NAME = Board Dimensions	GENERATED : 11/9/2017 3:44:43 AM	TEXAS INSTRUMENTS

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